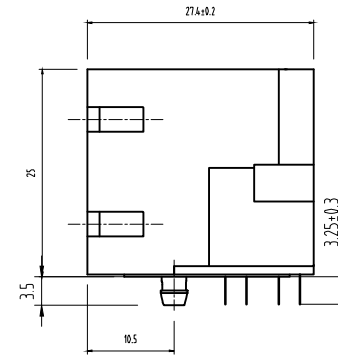
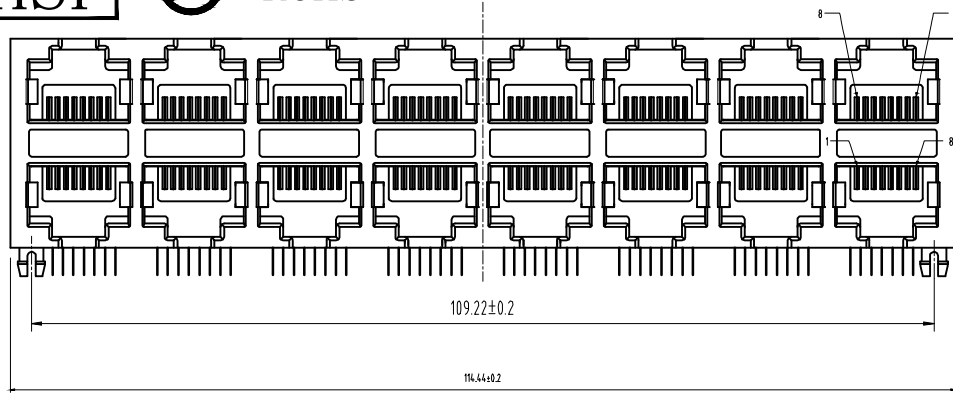


HSF



ROHS



- NOTES:
 MATERIAL:
 1. HOUSING MATERIAL:GLASS FILLED POYESTER UL94V-0.
 2. CONTACT MATERIAL:PHOSPHOR BRONZE $t=0.3\text{mm}$
 3. PLATING:SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATIN. OVER NICKEL IN SOLDER AREA
 4. SHIELD:0.2mm THICKNESS COPPER WITH NICKEL PLATEI
 ELECTRICAL
 1. VOLTAGE RATING:125V AC RMS
 2. CURRENT RATING:1.5AMP
 3. CONTACT RESISTANCE:30 MILLIOHMS MAX
 4. INSULATION RESISTANCE 500 MEGOHMS MIN @500V DC
 5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN

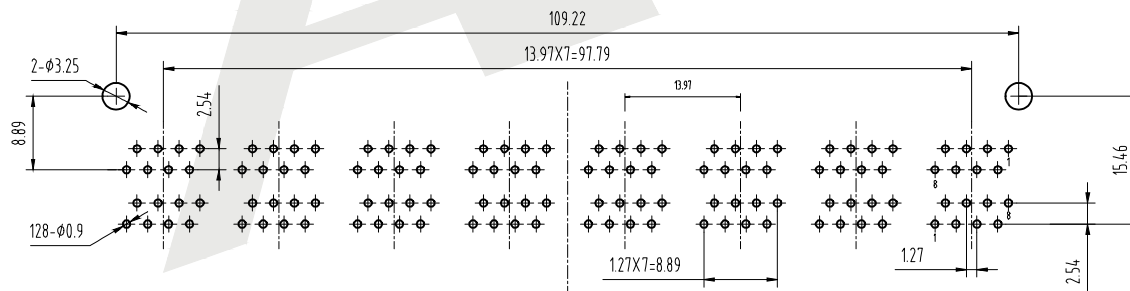
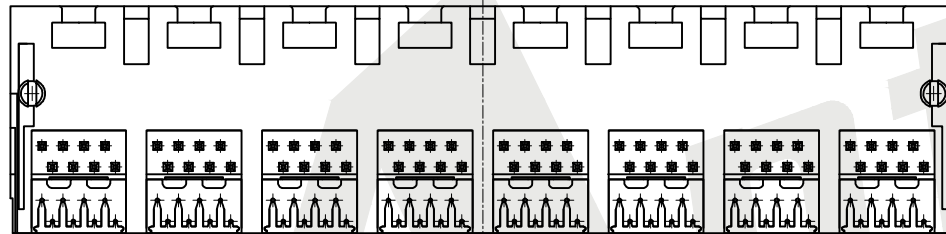
- MECHANICAL
 1. DURRABILITY:750 CYCLES MIN
 2. PCB RETENTON PRB-SOLDER:1 LB MIN
 REVRONMENTAL
 1. STORAGE:-40° C TO 85° C
 2. OPERATION:0° C TO 70° C

Order code:

ATRJ5921 - 8P - 8C - X - A - L

① ② ③ ④ ⑤ ⑥

- ① SERIES NO:
 ② NUMBER OF POSITIONS (10P, 8P, 6P, 4P)
 ③ NUMBER OF CONTACTS (10C, 8C, 6C, 4C)
 ④ Contact Plating
 G0:GOLD flash
 G1: 3U" Gold
 G2: 5U" Gold
 G3:10U" Gold
 G4:15U" Gold
 G5:30U" Gold
 SN:Tin
 ⑤ Shield
 A:W/O Shield
 B:Half Shield
 C:Shield W/Eml
 D:Shield W/O Eml
 ⑥ Ports
 A:1X1P G:2*1P
 B:1X2P H:2*2P
 C:1X4P I:2*3P
 D:1X5P J:2*4P
 E:1X6P K:2*6P
 F:1X8P L:2*8P



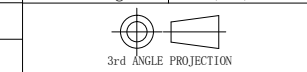
PC Board Layout
 Component Side Shown

Unless Otherwise specified tolerance
 X. ± 0.35 X.XX: ± 0.20
 X.X: ± 0.25 X.XXX: ± 0.15

Antenk ANTENK ELECTRONICS CO.,LTD
 Http://www.antenk.com
 E-mail:sales@antenk.com

SCALE: As Shown UNIT: mm
 DRAW Wu Feng Rong DATE 22/03/2018
 CHECK BobYang DATE 22/03/2018

TITLE:
 RJ45 Jack side entry Full plastic 2X8P



DRAWING NO: ATRJ5921-8P8C-X-A-L
 PRODUCT NO: ATRJ5921-8P8C-X-A-L

REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		